

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Priority Application Serial No. 09/281,735
 Priority Filing Date March 30, 1999
 Inventor Eugene P. Marsh
 Assignee Micron Technology, Inc.
 Priority Group Art Unit 2811
 Priority Examiner H. Vu
 Attorney's Docket No. MI22-1284
 Title: Circuitry Comprising Roughened Platinum Layers, Platinum-
 Containing Materials, Capacitors Comprising Roughened
 Platinum Layers, Methods of Forming Roughened Layers of
 Platinum, and Methods of Forming Capacitors

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 E. Hillis
 11-22-99

PRELIMINARY AMENDMENT

To: Assistant Commissioner for Patents
 Washington, D.C. 20231

From: David G. Latwesen (Tel. 509-624-4276; Fax 509-838-3424)
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AMENDMENTSIn the Specification

At p. 1, before the "Technical Field" section, insert ✓

RELATED PATENT DATA

This patent resulted from a continuation application of U.S. Patent
 Application Serial No. 09/281,735, which was filed on March 30, 1999,
 which is a divisional application of U.S. Patent Application Serial
 No. 09/141,840, which was filed on August 27, 1998.

PAT 5,990,539

PAT 6,583,022

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